

# High Density Card Edge

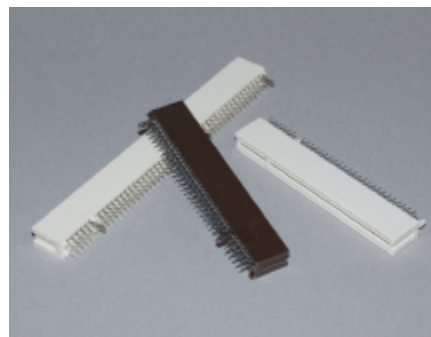
## 2 3 3 4 H S E R I E S

### Ratings:

Current	1A max.
Voltage	125V DC
Dielectric strength	500V AC for 1 minute
Contact resistance	20mΩ max.
Insulation resistance	1000MΩ
Durability	100 cycles

### Material:

Plastic	PPS, Glass-filled, UL94V-0
Contact	Phospher Bronze
Contact plating	Gold plated over nickel
Temperature	-55°C / +105°C



## Ordering Procedure:

1 - 2    3 - 4    5 - 6

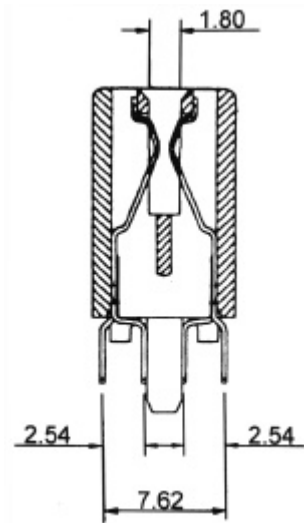
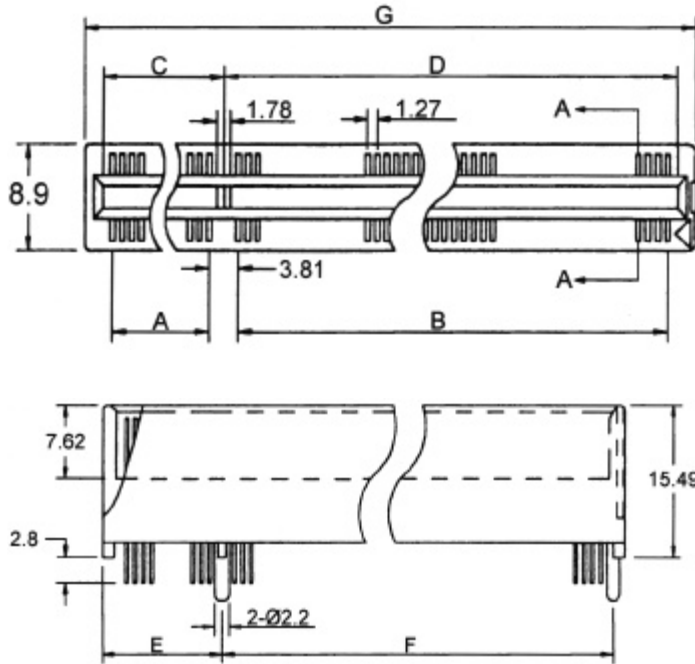
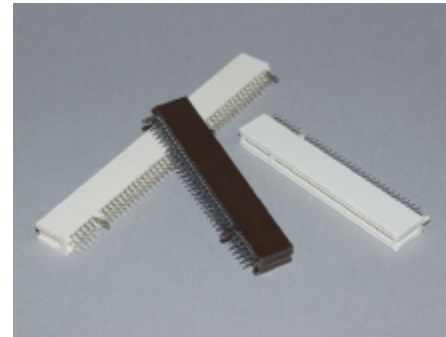
- 1) Series:
- 2) Positions: (see chart)
- 3) Plating:
  - 1 = Selective Gold Flash
  - 2 = Selective 10m Gold\*
  - 3 = Selective 30m Gold\*

\*May require minimums
- 4) Peg Type:
  - 0 = Plastic
  - 1 = Metal
- 5) Peg Options:
  - 2 = With 1 & 2 pegs
  - 3 = With 1, 2 & 3 pegs

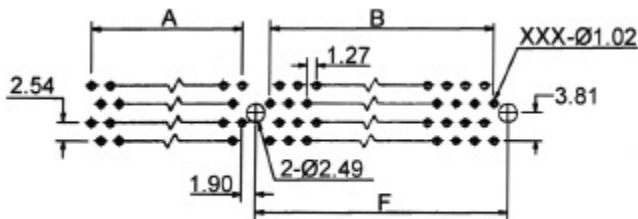
Please refer to the following pages for ordering examples.

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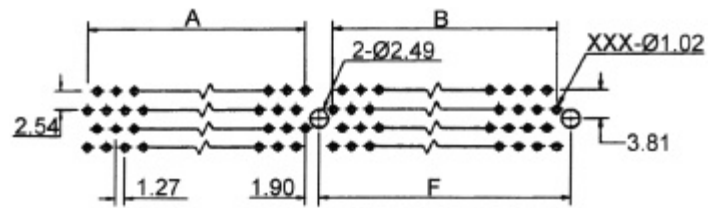
2 3 3 4 H S E R I E S



Section A-A



PC Board Layout (112, 120 pins)



PC Board Layout (182 pin)

## Ordering Example:

**2334H - 112 1**

Total Positions		Positions Per Row			Bay A	Bay B	Dimensions				
A	B	C	D	E	F	G					
112	56/112	11/22	45/90	12.70	55.88	15.88	59.06	18.29	59.69	79.76	
120	60/120	11/22	49/98	12.70	60.96	15.88	64.14	18.29	64.77	84.84	
182	91/182	42/84	49/98	52.07	60.96	55.25	64.14	57.66	64.77	124.21	